

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

REISSUE PATENT
APPLICATION TRANSMITTAL LETTER

Box PATENT APPLICATION
Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Enclosed for filing is the reissue patent application of Shinichi TAKAGI and Akinobu SUZUKI for U.S. Patent No. 5,986,337 entitled "Semiconductor Element Module and Semiconductor Device Which Prevents Short Circuiting".

Also enclosed are:

- [X] 6 sheet(s) of [X] formal [] informal drawing(s);
- [X] a claim for foreign priority under 35 U.S.C. §§ 119 and/or 365 is [X] hereby made to 9-315260 filed in Japan on 17 November 1997;
- [X] in the declaration;
- [] a certified copy of the priority document;
- [] an Assignment document;
- [X] an Information Disclosure Statement;
- [X] a patent application data sheet; and
- [X] Other: Consent of Assignee and Offer to Surrender.
- [X] An [X] executed [] unexecuted declaration of the inventor(s)
- [X] also is enclosed [] will follow.
- [] Please amend the specification by inserting before the first line the sentence --This application claims priority under 35 U.S.C. §§ 119 and/or 365 to filed in on ; the entire content of which is hereby incorporated by reference.--
- [] Please amend the specification by inserting before the first line the sentence:
- This application is a continuation of International Application No. filed on , which International Application [] was [] was not published by the International Bureau in English on --.
- [] Small entity status is hereby claimed.



21839

[X] The filing fee has been calculated as follows [] and in accordance with the enclosed preliminary amendment:

C L A I M S					
	NO. OF CLAIMS		EXTRA CLAIMS	RATE	FEE
Basic Application Fee					\$740.00 (101)
Total Claims	62	MINUS 20 =	42	× \$18.00 (103) =	756.00
Independent Claims	29	MINUS 6 =	23	× \$84.00 (102) =	1,932.00
If multiple dependent claims are presented, add \$280.00 (104)					-0-
Total Application Fee					3,428.00
If small entity status is claimed, subtract 50% of Total Application Fee					-0-
Add Assignment Recording Fee \$40.00 (581) if Assignment document is enclosed					-0-
TOTAL APPLICATION FEE DUE					3,428.00

- [] This application is being filed without a filing fee. Issuance of a Notice to File Missing Parts of Application is respectfully requested.
- [X] A check in the amount of \$ 3,428.00 is enclosed for the fee due.
- [] Charge \$ _____ to Deposit Account No. 02-4800 for the fee due.
- [X] The Commissioner is hereby authorized to charge any appropriate fees under 37 C.F.R. §§ 1.16, 1.17 and 1.21 that may be required by this paper, and to credit any overpayment, to Deposit Account No. 02-4800. This paper is submitted in duplicate.

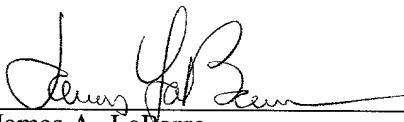
Please address all correspondence concerning the present application to:

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Respectfully submitted,

BURNS, DOANE, SWECKER & MATHIS, L.L.P.

Date: November 14, 2001

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Application of)
Shinichi TAKAGI et al) Group Art Unit: 2815
Patent No.: 5,986,337) Examiner: Unassigned
Filed: Herewith)
For: SEMICONDUCTOR ELEMENT)
MODULE AND SEMICONDUCTOR)
DEVICE WHICH PREVENTS)
SHORT CIRCUITING)

**CONSENT OF ASSIGNEE AND
OFFER TO SURRENDER ORIGINAL PATENT**

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Mitsubishi Denki Kabushiki Kaisha is the owner of the entire right, title and interest in the above-identified patent, as recorded in the U.S. Patent and Trademark Office at Reel 9413, Frame 0387.

The assignee consents to the filing of the accompanying application to reissue the patent, and hereby offers to surrender the original patent upon allowance of the reissue application.

The undersigned is authorized to sign this submission on behalf of the assignee.

Respectfully submitted,

MITSUBISHI DENKI KABUSHIKI KAISHA

By: Yoshi Kuwano
Yoshi Kuwano

Title: General Manager, Patent Administration
Department